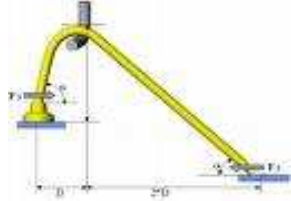


Packaging Solutions

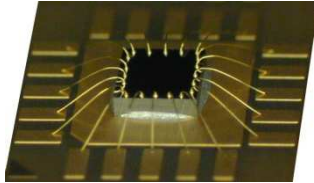
PVA TEPLA
Bond Pads cleaning
Flip-Chip Underfill



AMADYNE
Die Bonders



XYZTEC
Pull/Shear Test systems



TPT Wire Bonders

